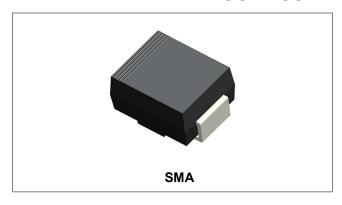






# ES2A-ES2J SURFACE MOUNT SUPER FAST RECTIFIER



#### **Features**

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Overload Drop, High Efficiency
- Low Power Loss
- Super-Fast Recovery Time
- Plastic Case Material has UL Flammability Classification Rating 94V-O
- This is a Pb Free Device
- . All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

## **Circuit Diagram**



#### **Mechanical Data**

- Case: Low Profile Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Cathode Band or Cathode Notch
- Marking: Type NumberWeight: 0.06 grams(approx)

## Maximum Ratings and Electrical Characteristics @TA=25°C unless otherwise specified

Characteristic	Symbol	ES2A	ES2B	ES2C	ES2D	ES2E	ES2G	ES2J	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	150	200	300	400	600	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	34	70	105	140	210	280	420	
Average Rectified Output Current @T <sub>L</sub> = 110°C	lo	2.0				Α			
Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	IFSM	50				А			
Forward Voltage @I <sub>F</sub> = 2.0A, T <sub>J</sub> =25°C	V <sub>F</sub>	0.95 1.25 1.7		1.7	V				
Maximum DC reverse current $T_A = 25^{\circ}C$ at rated DC blocking voltage $T_A = 100^{\circ}C$	I <sub>R</sub>	5.0 500				μA			
Typical junction capacitance (Note 1)	CJ	25			pF				
Maximum Reverse Recovery Time (Note 2)	Trr	35			ns				
Typical thermal resistance (Note 3)	R <sub>θJL</sub>	20		K/W					
Operating junction and storage temperature range	T <sub>J</sub> ,T <sub>STG</sub>	-55 to +150		°C					

 $\textbf{Note} \colon \ 1. \ \text{Measured at } 1.0 \ \text{MHZ} \ \text{and applied reverse voltage of } 4.0 \ V_{\text{DC}}$ 

- 2. Measured with  $I_F$ =0.5A,  $I_R$ =1.0A,  $I_{rr}$ =0.25A
- 3. Mounted on P.C. Board with 8.0mm<sup>2</sup> lead area
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### **Ratings and Characteristics Curves**

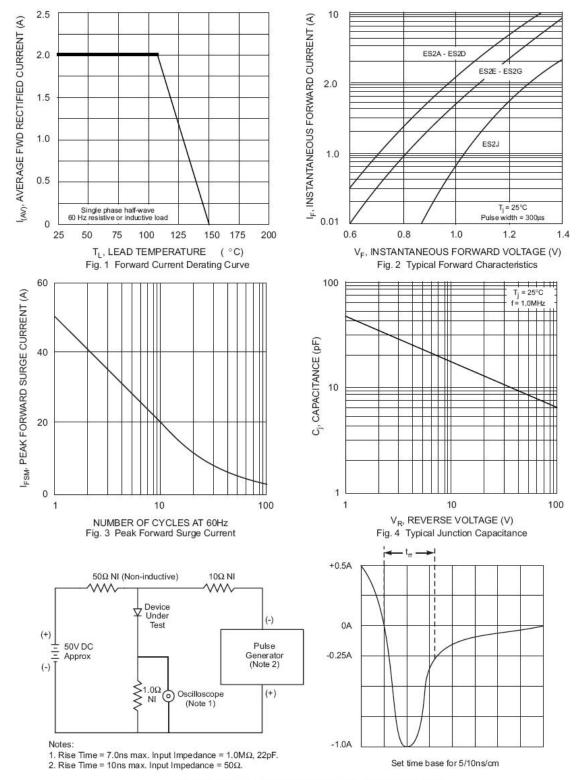


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

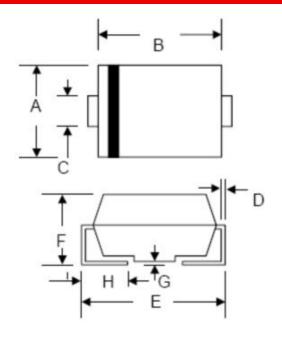
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#### **Mechanical Dimensions SMA**



SYMBOL	Milli	meters	Inches			
STWBUL	Min.	Max.	Min.	Max.		
Α	2.18	2.90	0.086	0.114		
В	3.99	4.60	0.157	0.181		
С	1.29	1.70	0.508	0.067		
D	0.152	0.305	0.006	0.012		
E	4.70	5.31	0.185	0.209		
F	1.70	2.50	0.067	0.098		
G	0.051	0.203	0.002	0.008		
Н	0.76	1.55	0.030	0.610		

## **Ordering Information**

Device Package		Shipping		
ES2A-ES2M	SMA (Pb-Free)	5000pcs / reel		

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

## **Marking Diagram**

Where XXXXX is YYWWL

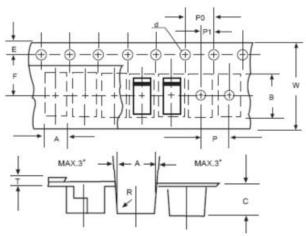


L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

## **Carrier Tape Specification SMA**



SYMBOL	Millimeters			
STWIBUL	Min.	Max.		
Α	2.97	3.17		
В	5.70	5.90		
С	2.32	2.52		
d	1.40	1.60		
E	1.40	1.60		
F	5.60	5.70		
Р	3.90	4.10		
P0	3.90	4.10		
P1	1.90	2.10		
Т	0.25	0.35		
W	11.80	12.20		

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